

DARLINGTON POWER TRANSISTOR 2SC4811

NPN SILICON EPITAXIAL TRANSISTOR (DARLINGTON CONNECTION) FOR HIGH-SPEED SWITCHING

The 2SC4811 is a high-speed Darlington power transistor. This transistor is ideal for high-precision control such as PWM control for pulse motors or brushless motors in OA and FA equipment.

In addition, this transistor features a package that can be auto-mounted in radial taping specifications, thus contributing to mounting cost reduction.

FEATURES

- Auto-mounting possible in radial taping specifications
- · Resin-molded insulation type package with power rating of 1.8 W in stand-alone conditions
- · On-chip C-to-E reverse diode
- · Fast switching speed

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

| Parameter | Symbol | Ratings | Unit |
|------------------------------|--------------------|-------------|------|
| Collector to base voltage | Vcво | 100 | V |
| Collector to emitter voltage | VCEO | 100 | V |
| Emitter to base voltage | VEBO | 8.0 | V |
| Collector current (DC) | Ic(DC) | ±8.0 | Α |
| Collector current (pulse) | IC(pulse)* | ±16 | Α |
| Base current (DC) | I _{B(DC)} | 0.8 | Α |
| Total power dissipation | Р⊤** | 1.8 | W |
| Junction temperature | Tj | 150 | °C |
| Storage temperature | T _{stg} | −55 to +150 | °C |

^{*} PW \leq 300 μ s, duty cycle \leq 10%

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^{**} Ta = 25°C



ELECTRICAL CHARACTERISTICS (Ta = 25°C)

| Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|------------------------------|------------------------|---|-------|------|--------|------|
| Collector cutoff current | Ісво | Vcb = 100 V, IE = 0 | | | 1.0 | μΑ |
| Emitter cutoff current | ІЕВО | V _{EB} = 5 V, I _C = 0 | | | 5.0 | mA |
| DC current gain | h _{FE1} * | Vce = 2.0 V, Ic = 4.0 A | 2,000 | | 20,000 | |
| DC current gain | hFE2* | Vce = 2.0 V, Ic = 8.0 A | 500 | | | |
| Collector saturation voltage | V _{CE(sat)} * | Ic = 4.0 A, IB = 4.0 mA | | | 1.5 | ٧ |
| Base saturation voltage | V _{BE(sat)} * | Ic = 4.0 A, IB = 4.0 mA | | | 2.0 | ٧ |
| Turn-on time | ton | $Ic = 4.0 \text{ A}, I_{B1} = -I_{B2} = 4.0 \text{ mA}$ | | 0.5 | | μs |
| Storage time | tstg | $R_L = 12.5 \Omega$, $V_{CC} \cong 50 V$ Refer to the test circuit. | | 2.5 | | μs |
| Fall time | t _f | nelei to the test circuit. | | 0.6 | | μs |
| Collector capacitance | Cob | VcB = 10 V, IE = 0 , f = 1 MHz | | 45 | | pF |

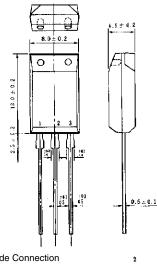
^{*} Pulse test PW \leq 350 μ s, duty cycle \leq 2%

hfe CLASSIFICATION

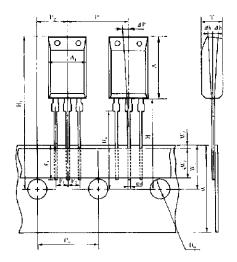
| Marking | М | L | K |
|------------------|----------------|-----------------|-----------------|
| h _{FE1} | 2,000 to 5,000 | 4,000 to 10,000 | 8,000 to 20,000 |

PACKAGE DRAWING (UNIT: mm)

TAPING SPECIFICATION



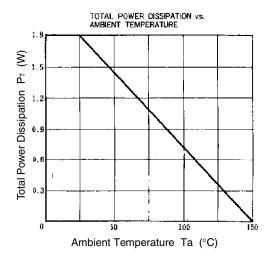


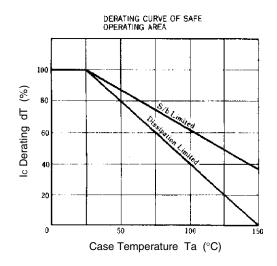


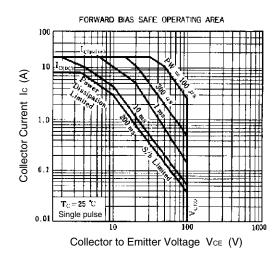
| \mathbf{A}_{t} | $\textbf{8.0} \pm \textbf{0.2}$ |
|---------------------------|---------------------------------|
| Λ | 13.0 ± 0.2 |
| $\mathbf{D_0}$ | $\phi 4.0 \pm 0.2$ |
| đ | 0.5 ± 0.1 |
| F, | 2.5+0.4 |
| \mathbf{F}_2 | 2.5-0.4 |
| Н | 20.0 MAX. |
| H_0 | 16.0 ± 0.5 |
| Н, | 32.2 MAX. |
| ⊿h | 0 + 1.0 |
| ê, | 2.5 MIN. |
| P | 12.7 ± 1.0 |
| P_0 | 12.7 ± 0.3 |
| P_2 | 6.35 ± 0.5 |
| ⊿P | 0 1 1.3 |
| T | 4.5 + 0.2 |
| W | 18.0 +1.0 |
| W_{o} | 5.0 MIN. |
| W, | 9.0 ± 0.5 |
| W_2 | 0.7 MIN. |
| | |

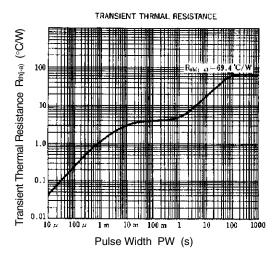


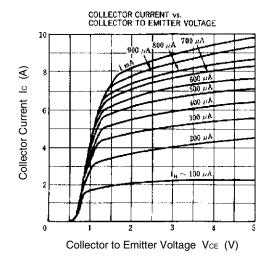
TYPICAL CHARACTERISTICS (Ta = 25°C)

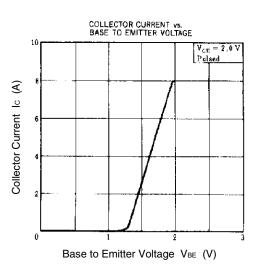




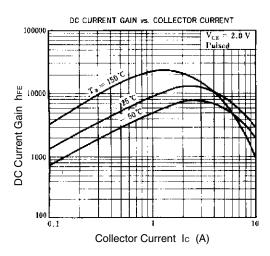


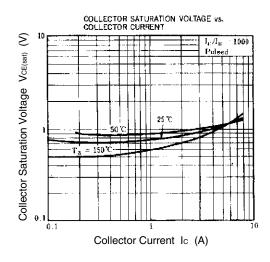


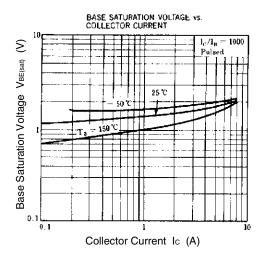


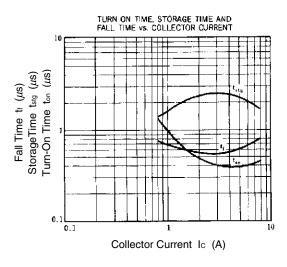


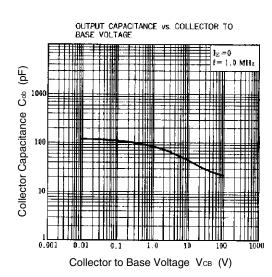
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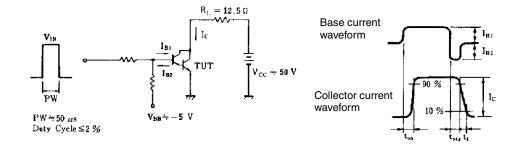








SWITCHING TIME (ton, tstg, tf) TEST CIRCUIT



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